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- (71) Applicant (for all designated States except US): SHOWA DENKO K.K. [JP/JP]; 13-9, Shiba Daimon 1-chome, Minato-ku, Tokyo 1058518 (JP).
- (72) Inventors; and
- (75) Inventors/Applicants (for US only): ISHIGAKI, Satoru [JP/JP]; C/o Corporate R & D Center (kawasaki), Showa Denko K.K., 5-1, Ogimachi, Kawasaki-ku, Kawasaki-shi, Kanagawa 2100867 $\overline{\mbox{(JP)}}$. MATSUKI, Kunio $\overline{\mbox{[JP/JP]}}$; C/o Corporate R & D Center (kawasaki), Showa Denko K.K., 5-1, Ogimachi, Kawasaki-ku, Kawasaki-shi, Kanagawa 2100867 (JP).
- (74) Agents: AOKI, Atsushi et al.; Ishida & Associates, Toranomon 37 Mori Bldg., 5-1, Toranomon 3-chome, Minato-ku, Tokyo 1058423 (JP).

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(54) Title: RESIST COMPOSITION

(57) Abstract: There is provided a resist composition used for the production of printed boards, which comprises (A) a resin component, (B) a photopolymerization initiator, (C) water and (D) an organic solvent, wherein the organic solvent (D) contains: (D-1) at least one organic solvent selected from the group consisting of an (-hydroxycarboxylate ester, a (-alkoxycarboxylate ester, a 1,3-diol compound and a 1,3-diol compound derivative, and (D-2) an organic solvent having a hydroxyl group other than (D-1).



